

PMSTA55; PMSTA56

PNP general purpose transistors Rev. 04 — 17 January 2008

Product data sheet

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NXP Semiconductors



PMSTA55; PMSTA56

FEATURES

- High current (max. 500 mA)
- Low voltage (max. 80 V).

APPLICATIONS

• Intended for telephony and professional communication equipment.

DESCRIPTION

PNP transistor in a SOT323 plastic package. NPN complements: PMSTA05 and PMSTA06.

MARKING

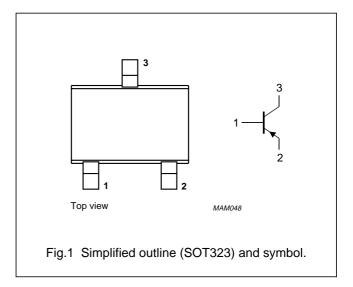
TYPE NUMBER	MARKING CODE ⁽¹⁾
PMSTA55	*2H
PMSTA56	*2G

Note

* = - : Made in Hong Kong.
 * = t : Made in Malaysia.

PINNING

PIN	DESCRIPTION				
1	base				
2	emitter				
3	collector				



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	PMSTA55		-	-60	V
	PMSTA56		_	-80	V
V _{CEO}	collector-emitter voltage	open base			
	PMSTA55		-	-60	V
	PMSTA56		-	-80	V
V _{EBO}	emitter-base voltage	open collector	_	-4	V
Ic	collector current (DC)		_	-500	mA
I _{CM}	peak collector current		_	-500	mA
I _{BM}	peak base current		_	-500	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	200	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board.

NXP Semiconductors Product specification

PNP general purpose transistors

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	625	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector cut-off current				
	PMSTA55	$I_E = 0; V_{CB} = -60 \text{ V}$	_	-100	nA
	PMSTA56	$I_E = 0; V_{CB} = -80 \text{ V}$	_	-100	nA
I _{EBO}	emitter cut-off current	I _C = 0; V _{EB} = -4 V	_	-500	nA
h _{FE}	DC current gain	$I_C = -10 \text{ mA}; V_{CE} = -1 \text{ V}$	100	_	
		$I_C = -100 \text{ mA}; V_{CE} = -1 \text{ V}; \text{ note 1}$	100	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -100 \text{ mA}; I_B = -10 \text{ mA}$	_	-250	mV
V _{BE}	base-emitter voltage	$I_C = -100 \text{ mA}; V_{CE} = -1 \text{ V}; \text{ note 1}$	_	-1.2	mV
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -1 \text{ V};$ f = 100 MHz	50	_	MHz

Note

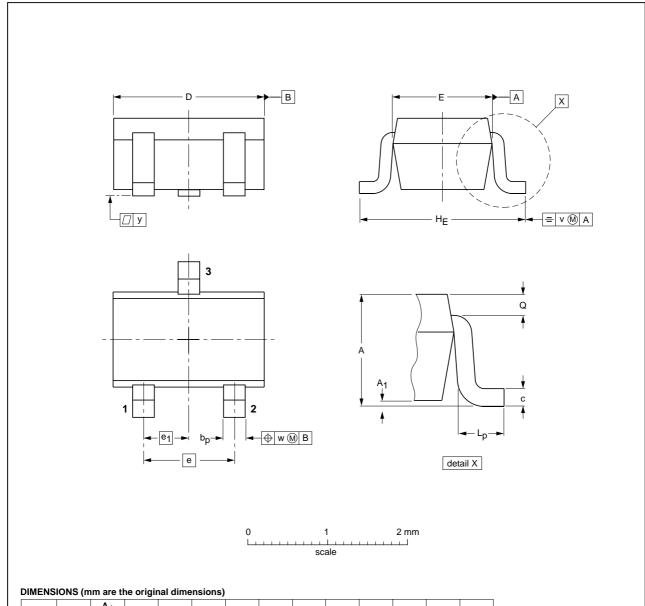
1. Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

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PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT323



UNI	Α	A ₁ max	bp	С	D	E	е	e ₁	HE	Lp	Q	v	w
mm	1.1 0.8	0.1	0.4 0.3	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.23 0.13	0.2	0.2

OUTLINE		REFERENCES				ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT323			SC-70			04-11-04 06-03-16	

Legal information

Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Revision history

Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMSTA55_56_N_4	20080117	Product data sheet	-	PMSTA55_56_3
Modifications:	 Marking table 	e on page 2; changed type nur	nber	
PMSTA55_56_3 (9397 750 05711)	19990422	Product specification	-	PMSTA55_56_2
PMSTA55_56_2 (9397 750 04099)	19980721	Product specification	-	PMSTA55_56_1
PMSTA55_56_1 (9397 750 01579)	19970602	Product specification	-	-

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